



SBR140LP

1.0A SBR® SUPER BARRIER RECTIFIER

Features

- Ultra Low Forward Voltage Drop
- **Excellent High Temperature Stability**
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1411-3
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208@3
- Weight: 2.35 grams (Approximate)

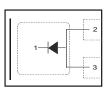
X1-DFN1411-3







Bottom



Top View Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging	
SBR140LP-7	X1-DFN1411-3	3,000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Code

X1-DFN1411-3



D4, D4= Product Type Marking Code YM = Date Code Marking Y = Year ex: C = 2015 M = Month (ex: 9 = September)

	Month	Jan	Feb	Mar	Apr	Mav	Jun	Jul	Aua	Sep	Oct	Nov	Dec
	Code	V	W	Х	Y	Z	Α	В		С	D	Е	F
	Year	2008	2009	2010	2011	2012	2013	201	4 2	2015	2016	2017	2018
Dat	te Code Key												



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	٧
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See Figure 1)	Io	1.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	5	A

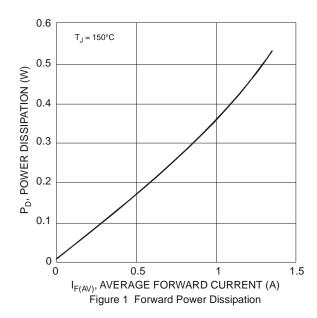
Thermal Characteristics

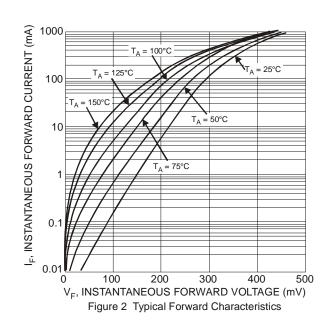
Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient (Note 6)	$R_{ hetaJA}$	300	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

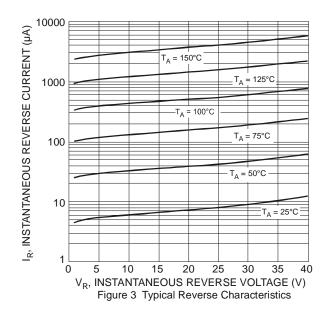
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	40	-	_	V	$I_R = 100 \mu A$
Forward Voltage Drop	V _F	_	0.47	0.55	· · · /	I _F = 1.0A, T _J = +25°C
Forward voltage Drop		_	0.44	0.53		$I_F = 1.0A, T_J = +125$ °C
Leakage Current (Note 7)		_	_	0.5	I MA	V _R =40V, T _J = +25°C
Leakage Current (Note 1)	IR	_	_	100		$V_R = 40V, T_J = +125$ °C

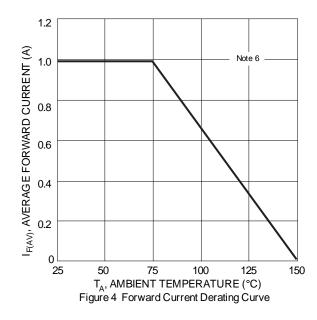
Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 7. Short duration pulse test used to minimize self-heating effect.





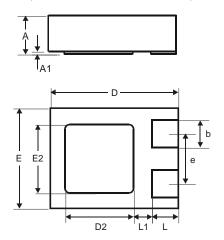






Package Outline Dimensions

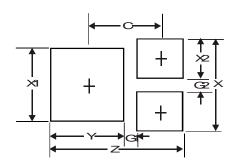
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1411-3							
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A1	0	0.05	0.02				
b	0.25	0.35	0.30				
D	1.35	1.475	1.40				
D2	0.65	0.85	0.75				
Е	1.05	1.175	1.10				
E2	0.65	0.85	0.75				
е			0.55				
L	0.225	0.325	0.275				
L1	_	_	0.20				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	1.38
G1	0.15
G2	0.15
Х	0.95
X1	0.75
X2	0.40
Υ	0.75
С	0.76



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